



**Cookson Electronics** ASSEMBLY MATERIALS

## PROGRAMME

### Soldering Seminar September 13, 2007

- 9:00 REGISTRATION
- 9:15 INTRODUCTION: **László Rédey**
- 9:30 SECTION ONE: **Steve Brown** – SACX™ and SACX™ Eco product families, applications, support.
- 10:30 COFFEE BREAK
- 11:00 SECTION TWO: **Tom Meeus, Martin Kovac, Tamás Erdősi** – Cookson stencil services: Design assistance, Customer specific rule-sets, Prototyping support, Technical novelties
- 12:30 LUNCH
- 13:45 SECTION THREE: **Gilbert Renaud** – Technical Experiences in wave soldering – interactive session
- 15:00 COFFEE BREAK
- 15:30 SECTION FOUR: **Gilbert Renaud** – Technical Experiences in reflow soldering – interactive session
- 17:00 CLOSING